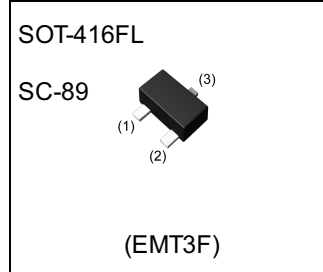


| Parameter | Value |
|---------------|---------------|
| V_{CC} | -50V |
| $I_{C(MAX.)}$ | -100mA |
| R_1 | 2.2k Ω |
| R_2 | 47k Ω |

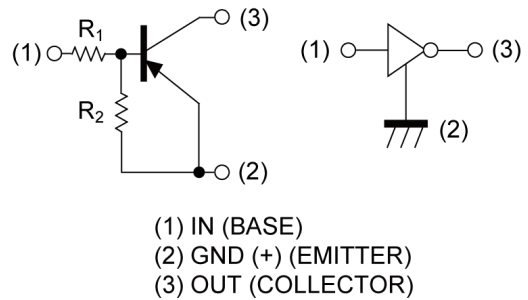
●Outline



●Features

- 1) Built-In Biasing Resistors, $R_1 = 2.2k\Omega$, $R_2 = 47k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit) .
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC123JEB HZG

●Inner circuit



●Application

INVERTER, INTERFACE, DRIVER

●Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|---------------|-------------------|--------------|-------------|----------------|-----------------|---------------------------|---------|
| DTA123JEB HZG | SOT-416FL (EMT3F) | 1616 | TL | 180 | 8 | 3000 | E32 |

● **Absolute maximum ratings** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Values | Unit |
|------------------------------|-------------------|-------------|------------------|
| Supply voltage | V_{CC} | -50 | V |
| Input voltage | V_{IN} | -12 to 5 | V |
| Output current | I_O | -100 | mA |
| Collector current | $I_{C(MAX)}^{*1}$ | -100 | mA |
| Power dissipation | P_D^{*2} | 150 | mW |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Range of storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

● **Electrical characteristics** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|----------------------|--------------|--|--------|------|------|------------|
| | | | Min. | Typ. | Max. | |
| Input voltage | $V_{I(off)}$ | $V_{CC} = -5V, I_O = -100\mu\text{A}$ | - | - | -0.5 | V |
| | $V_{I(on)}$ | $V_O = -0.3V, I_O = -5\text{mA}$ | -1.1 | - | - | |
| Output voltage | $V_{O(on)}$ | $I_O = -5\text{mA}, I_I = -0.25\text{mA}$ | - | -100 | -300 | mV |
| Input current | I_I | $V_I = -5V$ | - | - | -3.6 | mA |
| Output current | $I_{O(off)}$ | $V_{CC} = -50V, V_I = 0V$ | - | - | -500 | nA |
| DC current gain | G_I | $V_O = -5V, I_O = -10\text{mA}$ | 80 | - | - | - |
| Input resistance | R_I | - | 1.54 | 2.2 | 2.86 | k Ω |
| Resistance ratio | R_2/R_1 | - | 17 | 21 | 26 | - |
| Transition frequency | f_T^{*1} | $V_{CE} = -10V, I_E = 5\text{mA}, f = 100\text{MHz}$ | - | 250 | - | MHz |

*1 Characteristics of built-in transistor.

*2 Each terminal mounted on a reference land.

● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.1 Input voltage vs. output current (ON characteristics)

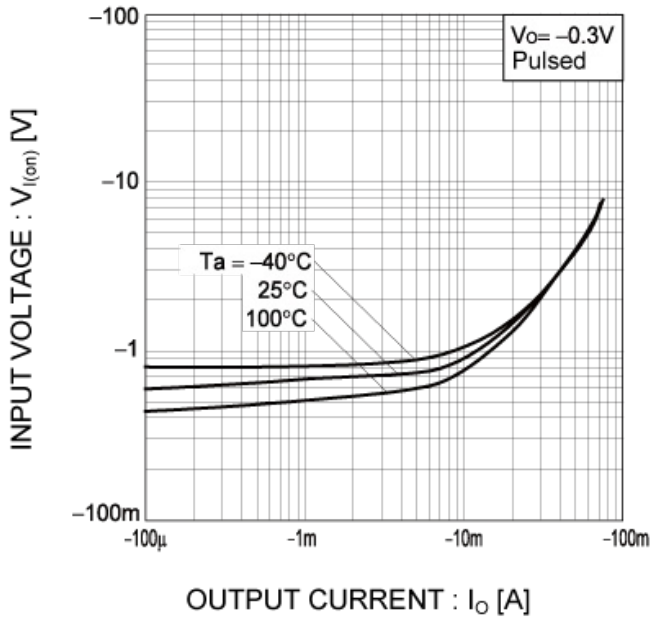


Fig.2 Output current vs. input voltage (OFF characteristics)

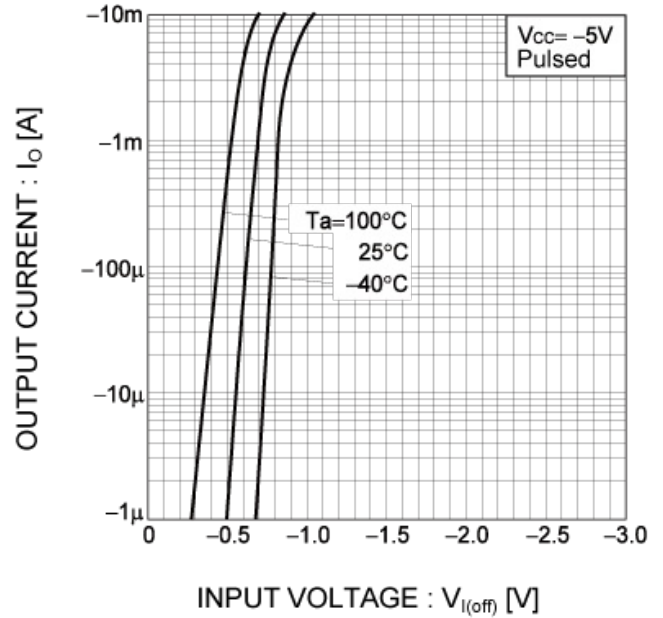


Fig.3 Output current vs. output voltage

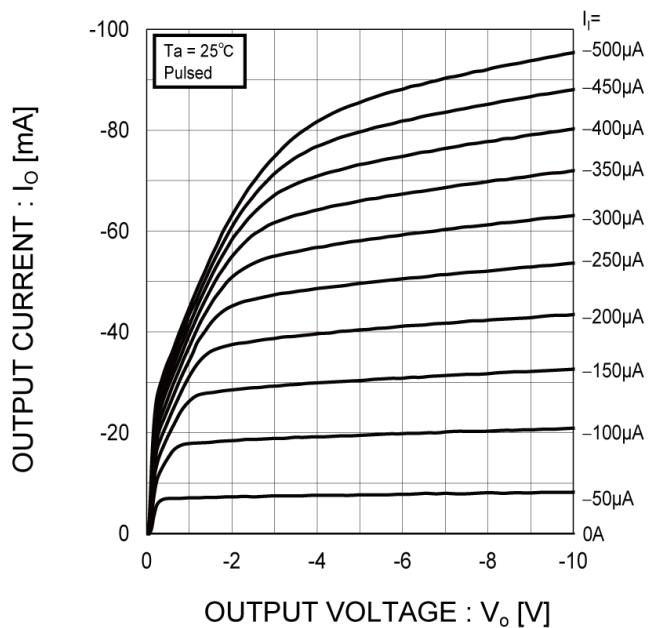
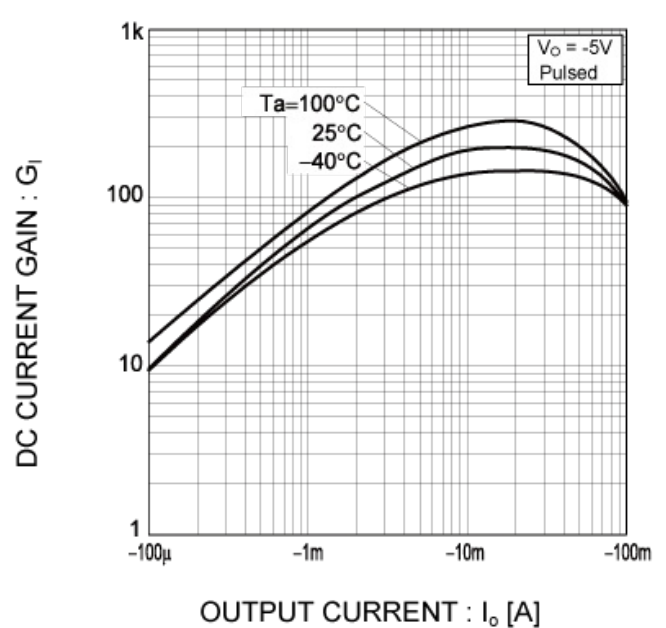
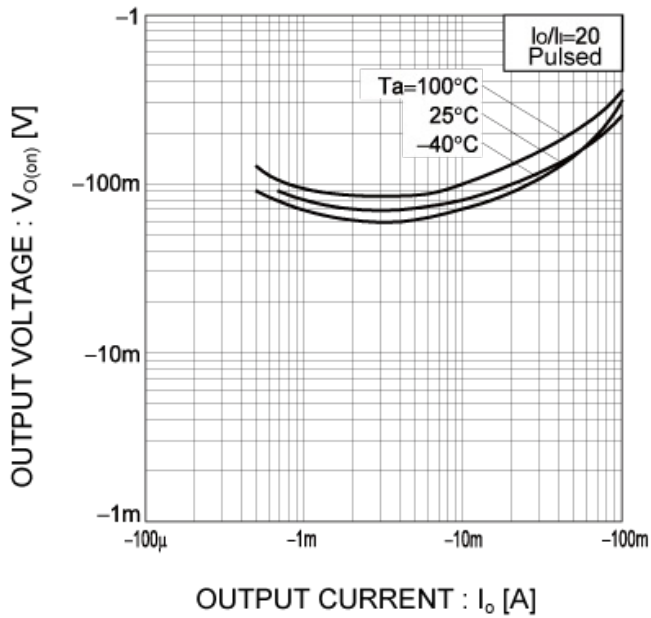


Fig.4 DC current gain vs. output current



● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.5 Output voltage vs. output current



●Dimensions

SOT-416FL
SC-89
(EMT3F)



| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.65 | 0.85 | 0.026 | 0.033 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A2 | 0.60 | 0.80 | 0.024 | 0.031 |
| b | 0.21 | 0.36 | 0.008 | 0.014 |
| c | 0.08 | 0.18 | 0.003 | 0.007 |
| D | 1.50 | 1.70 | 0.059 | 0.067 |
| E | 0.76 | 0.96 | 0.030 | 0.038 |
| e | 0.50 | | 0.020 | |
| HE | 1.50 | 1.70 | 0.059 | 0.067 |
| L | 0.37 | | 0.015 | |
| Lp | 0.35 | 0.55 | 0.014 | 0.022 |
| x | - | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| b2 | - | 0.46 | - | 0.018 |
| e1 | - | 1.05 | - | 0.041 |
| l1 | - | 0.65 | - | 0.026 |

Dimension in mm/inches

Notice

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV | | CLASS III | |

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
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 - [h] Use of the Products in places subject to dew condensation
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8. Confirm that operation temperature is within the specified range described in the product specification.
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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